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Morphology and microstructure evolution of Ti-50 at.% Al cathodes during cathodic arc deposition of Ti-Al-N coatings

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Today's research on the cathodic arc deposition technique and coatings therefrom primarily focuses on the effects of, e.g., nitrogen partial pressure, growth temperature, and substrate bias. Detailed studies on the morphology and structure of the starting material—the cathode—during film growth and its influence on coating properties at different process conditions are rare. This work aims to study the evolution of the converted layer, its morphology, and microstructure, as a function of the cathode material grain size during deposition of Ti-Al-N coatings. The coatings were reactively grown in pure N₂ discharges from powder metallurgically manufactured Ti-50 at.% Al cathodes with grain size distribution averages close to 1800, 100, 50, and 10 μm , respectively, and characterized with respect to microstructure, composition, and mechanical properties. The results indicate that for the cathode of 1800 μm grain size the disparity in the work function among parent phases plays a dominant role in the pronounced erosion of Al, which yields the coatings rich in macro-particles and of high Al content. We further observed that a reduction in the grain size of Ti-50 at.% Al cathodes to 10 μm provides favorable conditions for self-sustaining reactions between Ti and Al phases upon arcing to form γ phase. The combination of self-sustaining reaction and the arc process not only result in the formation of hole-like and sub-hole features on the converted layer but also generate coatings of high Al content and laden with macro-particles.

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I. INTRODUCTION

Cathodic arc deposition is the quotidian PVD technique used to deposit hard coatings on cutting tools. This technique owes its expedience to the fact that the metal plasma formed during the process is highly ionized and dense.¹ It begets good adhesion, high deposition rates, and dense coatings with compressive stress,² which result in superior mechanical properties.³

The demands for higher cutting speeds during turning and milling operations require the coatings on cutting tools to withstand extreme and harsh conditions of high temperatures and pressures, which has motivated extensive research on multinary ceramic materials. For example, detailed understanding and abundant research material on Ti-Al-N,⁴ Zr-Al-N,⁵ Ti-Si-N,⁶ etc., are readily available. Current research in this field has mainly been directed to tailor and understand the optimum microstructure by compositional variance. These multinary ceramic coatings are generally grown by using powder metallurgically produced multiphase cathodes, such as Ti-Al,⁷ Zr-Al,⁸ Ti-Si,⁹ etc., arced in the presence of the reactive gas N₂.

The perpetual existence of cathode spot(s) on the cathode surface is the very essence of the cathodic arc deposition process. In addition, the cathode spots dynamics can be influenced by, e.g., the microstructure of the cathode,

which in turn may lead to changes in the microstructure of the coatings and, hence, also of its properties.⁹ Depending on cathode material, the electron temperatures between 2 and 5 eV have been reported in the vicinity of cathode spots.¹⁰ The presence of such high electron temperatures, in proximity to the cathode surface, modifies its microstructure to a depth of several micrometers to form a converted layer.¹¹

Most investigations on how to control coating microstructure and composition by manipulating the cathodic arc process are chiefly focused on the aspects of ambient gas pressure,¹² bias voltage,¹³ deposition temperature,¹⁴ and magnetic steering¹⁵ of the cathode spot. However, the influence of the microstructure of the cathode on the synthesis of coating, their microstructure, and composition is almost never considered. Although the interplay of multiple phases in the cathode, the reactive gas, and the localized ultrahigh temperatures due to the transient nature of the cathode spots causes intermixing of the parent phases and the formation of new phases in the converted layer. In-depth knowledge of such mechanisms is needed for a comprehensive understanding of the arc deposition process and perhaps a mean to control the microstructure and composition of arc deposited coatings. This work focuses on the evolution of the converted layer on the cathode surface, its morphology, and microstructure, as a function of the Ti-50 at.% Al cathode

material, with the average grain size distribution ranging between 10 and 1800 μm , during the arc deposition of Ti-Al-N coatings. In addition, the effect of cathode material grain size on coating microstructure, composition, and mechanical properties is discussed.

II. EXPERIMENTAL DETAILS

Classified by different average grain sizes distributions, four grades of titanium–aluminum with equal atomic percentage were used in this study. The average grain sizes were 1800, 100, 50, and 10 μm and they were labeled as 1800 μm -grade, 100 μm -grade, 50 μm -grade, and 10 μm -grade, respectively. Monosized powder mixtures of Ti and Al were prepared by sieving to the right grain size and used as starting material during cathode manufacturing. All four grades were fabricated in the same manner, i.e., densification of the powder mixture by pressing and forging followed by solid state sintering at 400 °C. This fabrication route resulted in a solid material with a density greater than 99.7% of theoretical density and below 300 $\mu\text{g/g}$ of oxygen content.

In order to study the arc events on the virgin material, pieces with dimensions $1.5 \times 1.5 \times 0.5 \text{ cm}^3$ were cut by a diamond blade from all four grades. These pieces were then polished to a mirror like finish by following the series of grinding, lapping, and polishing steps. The pieces were then cleaned in an ultrasonic ethanol bath. Each piece was fastened with electrically conducting silver containing glue on the surface of a dummy cathode [shown in Fig. 1(a)]. The triggering event serves a dual purpose, one being the initiation of the arc and the other being that the mechanical force imparted by the trigger on the piece breaks free the established electrical contact between the piece and the dummy cathode. This ensures that the arc traverses the surface of the piece only once (single trigger event). An industrial arc chamber (Metaplas MZR323) was used for all the experiments. The parameters used during the arcing of the pieces were $2.0 \times 10^{-6} \text{ Pa}$ base pressure, 4.5 Pa nitrogen pressure, and 80 A arc current.

To capture the surface state after multiple arcing events (steady state arcing) and to analyze differences in the resulting coatings, full sized circular cathodes having a diameter of 63 mm were also made from all four grades. These cathodes were arced in N_2 (reactive) ambience with the

parameters of $2.0 \times 10^{-6} \text{ Pa}$ base pressure, 4.5 Pa N_2 pressure, -30 V bias voltage, 75 A arc current, 300 °C process temperature, and a constant evaporation time is achieved by a predetermined setpoint of 300 Ah. Coatings were deposited on polished and ultrasonically cleaned WC-13 wt. % Co substrates (ISO SNUN120408, $1.2 \times 1.2 \times 0.5 \text{ cm}^3$) mounted on a drum fixture rotating with a speed of 3 rpm as shown in Fig. 1(b). Seven substrates were mounted such that they covered an angular range of 0° to 49° from the surface normal of the cathode. Prior to the deposition of coatings, the substrates were etched with Ar ions.

The microstructures of virgin and arced material, as well as the coatings, were investigated using a LEO 1550 SEM equipped with an Oxford energy dispersive x-ray spectrometer (EDX). An acceleration voltage of 10 kV at a working distance of 5 mm was used for imaging, while an acceleration voltage of 20 kV at a working distance of 8.5 mm was used for elemental mapping and compositional analysis. A TiAlN sample of known composition was used to obtain calibrated EDX data, resulting in an accuracy of the compositional analysis of 5 at.%. For viewing the microstructure of the converted layers by SEM, cross-sectional samples having dimensions of $1 \times 0.5 \times 0.5 \text{ cm}^3$ were cut by a diamond blade. These samples were then embedded in a carbon based resin and polished by using the same regimen mentioned earlier.

A Zeiss 1540 EsB CrossBeam (FIB) was used to section the cathode surface features to reveal their microstructure. The macro-particle areal density of the coatings was measured by the box-counting method, i.e., by dividing SEM micrograph with an area of 2015 μm^2 into 60 boxes and then counting the macro-particles in each box. The number of macro-particles counted from 60 boxes was then divided by the area of micrograph to calculate the areal density of macro-particles. The lower limit on the radii of countable macro-particles was set at 50 nm. Four micrographs from different locations along the diagonal of each coated substrate were used to gain a reliable average macro-particle areal density.

X-ray diffractometry of arced pieces, arced cathodes, and coatings was performed in 1° grazing incidence geometry¹⁶ using a PANalytical Empyrean diffractometer and Cu-K α radiation. Young's modulus of 429 GPa and

FIG. 1. (a) Schematic drawing of how a piece of Ti-50 at.% Al is glued to the surfaces of a dummy cathode. (b) Schematic drawing of the deposition geometry showing how the cathode, drum fixture, and the substrates were positioned (not to scale).

FIG. 2. SEM micrograph of virgin material (a) 1800 μm -grade, (b) 100 μm -grade, (c) 50 μm -grade, and (d) 10 μm -grade.

Poisson's ratio of 0.19, as indicated by Mittemeijer *et al.* for $\text{TiN}_{0.98}$,¹⁷ were used to measure the stress of the coatings by using the $\sin^2 \psi$ method.¹⁶

The hardness of the coatings was evaluated by using a diamond Berkovich tip mounted on a load-controlled UMIS nanoindenter. The area function of the tip was calibrated using a fused silica reference sample. The hardness measurements were obtained from load-displacement curves by employing the method developed by Oliver and Pharr.¹⁸ The hardness values reported were averaged from 40 indents at 25 mN load with a maximum achieved penetration depth of 0.18 μm on tapered (tapering angle 5°)¹⁹ and polished cross section of the coatings. The load of 25 mN and taper polishing were used to mitigate the influences from the substrate and surface roughness on the recorded hardness.

III. RESULTS

Figure 2 shows SEM micrographs of polished virgin materials prepared from four grades. The grain size evaluation by the tangent rule performed on these micrographs is in agreement with the result of the sieve analysis, suggesting limited or no grain growth during manufacturing. Figure 3 shows the x-ray diffractograms of polished virgin materials of all the four grades, showing that the virgin material of all four grades has a duplex structure of two phases: Al and Ti.

The traces of the arc on polished pieces of four different grades are shown in Fig. 4. In general, Al grains suffer more erosion than Ti grains, and the largest craters tend to appear at the shared peripheries of Ti and Al grains. The higher erosion rate of Al is expected since Al compared to Ti has a lower work function as well as cohesive energy. The reported work functions of Ti and Al ranges from 4.33 to 4.53 eV (Refs. 1, 20, and 21) and 4.08 to 4.28 eV,^{1,20,22} respectively. In the case of Ti-Si,⁹ Zhu *et al.* has shown that the phase with a low work function experiences a higher frequency of cathode spot events. The reported cohesive energies of Ti and Al are 4.86 eV/atom (Ref. 23) and 3.34 eV/atom,²³ respectively. It has been established that, in general, cohesive

energies of metals have an inverse relationship with the ion erosion rate.²⁴

On the 1800 μm -grade, the largest crater appears on an Al grain and in close proximity of a Ti grain, and the diameter of this crater is around 850 μm , while the largest crater on a Ti grain is around 43 μm . An additional feature appears on this grade in the form of macro-bubbles (solidified bubbles) of Al located at the interface between the Ti and Al grains, as shown by the overlaid EDX elemental map in Fig. 5(a). Figure 5(b) shows the FIB excavated cross-section of the macro-bubble, confirming that these features are hollow.

For the 100 μm -grade, the recorded diameter of the largest craters on Al and Ti grains are approximately 18 and 2 μm , respectively. For the 50 μm -grade, the channels of Al sandwiched between Ti grains suffer higher erosion, the craters left at this channel site encompass the Al channel as well as the edges of the Ti grains. The largest crater of such kind has an approximate diameter of 27 μm , while the largest crater left on the Al and Ti grains have diameters of around 5 μm and 2.5 μm , respectively.

FIG. 3. X-ray diffractograms of all four grades of virgin material.

FIG. 4. SEM micrograph showing arc traces from a single trigger event on (a) polished 1800 μm -grade, (b) polished 100 μm -grade with an inset showing a magnified micrograph of Ti grain, (c) polished 50 μm -grade (* denote the regions of arced Al sandwiched between Ti grains), and (d) polished 10 μm -grade.

FIG. 5. (a) Scanning electron micrograph of macro-bubble with an EDX elemental map. (b) The excavation of macro-bubble achieved by Fib.

The erosion on the 10 μm -grade appears to be more pronounced compared to both the 100 and 50 μm -grades. The largest observable crater on the 10 μm -grade has an approximate diameter of 35 μm . For the 10 μm -grade, the virgin material [see Fig. 2(d)] consists of Ti grains with a diameter smaller than 5 μm dispersed in the Al matrix. There appear to be abundant craters of diameters greater than 5 μm . This widespread dispersion of small Ti grains and abundance of craters larger than Ti grains makes it impossible to ascertain the diameter of largest craters on the Ti and Al grains.

The phase compositions of all the pieces after being arced with a single trigger event are shown in the x-ray diffractograms in Fig. 6. These diffractograms show that during the initial stage of arcing the 1800 μm -grade retains its virgin composition of Ti and Al, the 100 μm -grade also shows the existence of just virgin phases, the 50 μm -grade shows the additional trace of ζ (Al_5Ti_2), and the 10 μm -grade additionally contains the intermetallic phase η (Al_2Ti). Although the ambient gas during the single trigger event was N_2 , no N-containing compounds were detected.

The optical image in Figs. 7(a)–7(d) shows the virgin and worn cathodes of all the four grades. The roughness of arced cathodes can be seen to decrease from the 1800 μm -grade to 50 μm -grade and then increase for the 10 μm -grade. SEM micrographs of the topography of the converted layers are shown in Figs. 7(i)–7(iv). The converted layer on the 1800 μm -grade hosts craters with diameters ranging from sub-micron to 3100 μm . This converted layer is enriched

with craters of 2000 μm diameter. The crater diameters on the converted layer of 100 μm -grade range from sub-micron to 62 μm . The converted layer on the 50 μm -grade hosts craters as well as hole-like features. The diameters of the craters range from sub-micron to 70 μm . The average diameter of the hole-like features in the converted layer of the 50 μm -grade is 25 μm , and these hole-like features occasionally have sub-holes. The diameters of the craters on the converted layer of the 10 μm -grade range from sub-micron to 22 μm and the frequently occurring hole-like features are larger

FIG. 6. X-ray diffractograms of all four grades after a single trigger event.

FIG. 7. (a)–(d) Images of all four grades of virgin (V) as well as worn (W) cathodes; (i)–(iv) are SEM micrographs showing the topography of all four grades of cathodes, the encircled regions in (iii) and (iv) host hole-like features; (v) represent the topography of 10 μm -grade cathode at low magnification indicating the extent of population density of hole-like features while (vi) the higher magnification of hole-like feature on 10 μm -grade cathode taken by tilting the stage at 45°; this shows that multiple sub-holes reside in a hole-like feature.

with an average diameter of 35 μm and often contain multiple sub-holes, as shown in Fig. 7(vi).

The phase composition of the converted layers is shown by the x-ray diffractograms in Fig. 8. From the diffractograms, it can be seen that the converted layers on all the four grades of cathodes contain cubic(c)-TiAlN and the intermetallic phases ζ (Al_5Ti_2), ϵ (Al_3Ti), and η (Al_2Ti). The converted layers of the 1800 μm -grade and 100 μm -grade also contain the virgin Ti and Al phases. A reduction in grain size

to 50 μm results in the formation of the γ (AlTi) phase while the Al phase disappears from the converted layer. Further reduction in grain size to 10 μm enhances the intermixing of Al and Ti and now also the Ti phase disappears while the γ (AlTi) phase appears in the converted layer. This trend suggests that a reduction in grain size of the cathode material promotes the mixing of Ti and Al to form the γ phase.

Cross-sections of the converted layer on the four grades are shown in Fig. 9. The thickness of the converted layers are 14–50 μm , 2–20 μm , 6–40 μm , and 16–50 μm on 1800 μm -grade, 100 μm -grade, 50 μm -grade, and 10 μm -grade, respectively. No difference in the erosion of Ti and Al grains could be distinguished for the 100 μm -grade, while Al grains suffer higher erosion for all the other cathodes. Figs. 9(c) and 9(d) show cross-sections of the previously mentioned sub-holes. These sub-holes are present at the interface between the converted layer and the virgin microstructure. In fact, it appears as if the holes are located where there used to be Al-grains in the virgin microstructure. The summary of above mentioned results is tabulated in Table I.

Figure 10 shows plan view micrographs of the coatings grown by the four different cathode grades. These coatings are grown on WC-13 wt. % Co substrates placed at position 0, as indicated by the deposition geometry shown in Fig. 1(b). The coating grown by the 1800 μm -grade appears to be laden with spherical as well as flattened macro-particles. The coatings grown by the 100 μm -grade, as well as 50 μm -grade, have only spherical macro-particles, and the coating grown by

FIG. 8. X-ray diffractograms showing the phase analysis of the converted layers on all four grades of cathodes.

FIG. 9. SEM micrograph of the cross section of converted layers of (a) 1800 μm -grade, (b) 100 μm -grade, (c) 50 μm -grade, and (d) 10 μm -grade; the cross-section of sub-holes mentioned in Figs. 8(c) and 8(d) c.

TABLE I. Summarized attributes of all four grades on arcing.

Attribute	1800 μm -grade	100 μm -grade	50 μm -grade	10 μm -grade
Phases present (single trigger)	Ti, Al	Ti, Al	Ti, Al, ζ	Ti, Al, ζ , η
Largest crater diameter on Ti and Al grains	Al $\sim 850 \mu\text{m}$, Ti $\sim 43 \mu\text{m}$	Al $\sim 18 \mu\text{m}$, Ti $\sim 1.7 \mu\text{m}$	Al $\sim 5 \mu\text{m}$, Ti $\sim 2.5 \mu\text{m}$	Largest crater $\sim 35 \mu\text{m}$
Special features	Al macro-bubbles	...	Arced Al sandwiched between Ti grains	Pronounced erosion
Phases present (steady state)	Ti, Al, c-TiAlN, ζ , η , ϵ	Ti, Al, c-TiAlN, ζ , η , ϵ	Ti, c-TiAlN, ζ , η , ϵ , γ	c-TiAlN, ζ , η , ϵ , γ
Observable crater diameter	Sub-micron–3100 μm	Sub-micron–62 μm	Sub-micron–70 μm	Sub-micron–22 μm
Converted layer thickness	14–50 μm	2–20 μm	6–40 μm	16–50 μm
Special features	Large and deep craters	...	Hole-like features (sparse) with sub-holes	Hole-like features (frequent) with sub-holes

FIG. 10. SEM micrograph of the Ti-Al-N coatings (position 0 as shown in Fig. 2) deposited from (a) 1800 μm -grade, (b) 100 μm -grade, (c) 50 μm -grade and (d) 10 μm -grade; encircled regions in (a) and (d) denote flattened macro-particles.

the 100 μm -grade shows the fewest macro-particles among the four coatings. The coating grown by the 10 μm -grade have both flat and sphere shaped macro-particles [Fig. 12(d)]. The abundance of macro-particles on the coating

grown by the 10 and 1800 μm -grades makes the hardness measurements of these coatings unreliable. The coatings grown from the 50 and 100 μm -grades show a hardness of around 30 GPa.

The x-ray diffractograms shown in Fig. 11 indicate that the coatings are comprised of $c\text{-Ti}_{1-x}\text{Al}_x\text{N}$. Their residual stress is in the range of -2.5 to -3.1 GPa. Examination of the positions of the diffraction peaks illustrates shifts towards higher angles for the coatings grown from $1800\text{ }\mu\text{m}$ -grade and $10\text{ }\mu\text{m}$ -grade compared to those grown from the other grades. These shifts are larger than what is caused by the residual stress, and instead, they are the consequence of differences in chemical composition, i.e., coatings grown by the $1800\text{ }\mu\text{m}$ -grade and $10\text{ }\mu\text{m}$ -grades have a higher Al content than the other two coatings. The appearance of flattened macro-particles on these coatings suggests these macro-particles to have still been in a liquid state when impacting on the growing coating, and then solidified in a flat geometry.

The variation of the coating thickness and areal density of the macro-particles are plotted as a function of angular spread in Figs. 12 and 13, respectively. It should be noted that the angle of the angular spread represents the positions where the surface normal of the substrate become anti-parallel to the surface normal of the cathode during a revolution of the drum fixture [see Fig. 1(b)], i.e., the coating grown at position 0 is represented by 0° angular spread even though it traverses an angular distance of -30° to $+30^\circ$ in front of the cathode during the deposition. Coating thickness decreases with increasing distance from the cathode for all cathode grades, which is a result of the expected angular distribution of the ion flux from an arc cathode source.²⁵ However, the distinct differences between the cathode grades are seen. The coatings grown by the $10\text{ }\mu\text{m}$ -grade show the highest growth rate while the other 3 grades show similar and lower growth rate. The coatings grown from the $1800\text{ }\mu\text{m}$ -grade have the highest macro-particle areal density. The maximum macro-particle areal density for coatings grown by $1800\text{ }\mu\text{m}$ -grade, as well as coatings grown by the $10\text{ }\mu\text{m}$ -grade, occurs at an angular spread of $\sim 21^\circ$. For the coatings grown by the $50\text{ }\mu\text{m}$ -grade cathode, the maximum is shifted to $\sim 30^\circ$ and for the $100\text{ }\mu\text{m}$ -grade to $\sim 43^\circ$.

FIG. 11. XRD diffractograms of the coatings shown in Fig. 10; the measured residual stresses in the coatings are also stated along with the chemical composition.

FIG. 12. Graphical representation of the variation of the thickness of the coatings, grown from all four grades of the cathodes, as a function of the angular distance of the substrates from the surface normal of the cathode; the corresponding vertical distance of the substrates on the drum fixture is also shown.

IV. DISCUSSION

A. Formation and evolution of the converted layers

The composite manufactured material of all the four grades of Ti-50 at.% Al has a matrix of pure Al with Ti particles. Al suffers higher erosion compared to Ti during the initial stage of the formation of the converted layer, irrespective of the grain size. Several factors contribute to the higher erosion of Al, including the inverse relation between the ion erosion rate and cohesive energy of metals.²⁴ The cohesive energy of Al is approximately 1.5 eV/atom lower than Ti. A second factor favoring higher erosion of Al over Ti grains is

FIG. 13. Graphical representation of the macro-particle areal density of the coatings deposited from all four grades of the cathodes as a function of angular distance of the substrates from the surface normal of the cathode; the corresponding vertical distance of the substrates on the drum fixture is also shown; the inset shows the re-scaled version of the macro-particle areal density of the coatings deposited by $100\text{ }\mu\text{m}$ -grade.

the difference of 0.4 eV in work function. The cathodic arc evaporation process is perpetual in such a way that it keeps the supply of electrons to the anode from the cathode by continually igniting new cathode spots at locations on the cathode surface that offer the least resistance to electron emission. Since the work function is lower for Al than Ti, Al grains are expected to host more cathode spots, which contribute to the abundant erosion of Al. A third factor yielding a more pronounced erosion of Al than Ti is related to the fact that metals with low melting temperatures emanate more macro-particles.²⁶ The reported melting temperatures of Al and Ti are 660 °C (Ref. 27) and 1670 °C,²⁸ respectively. The temperature of the cathode surface close to a cathode spot is reported to be in the range of 1500–4500 °C depending on the cathode material.^{29–31} This temperature range is more than enough to melt the surface of both Ti and Al grains and the excess heat is dissipated by increasing the volume of the molten pool on the surface. Since Al has a lower melting temperature than Ti, the molten pools on Al grains are expected to be larger than those on Ti grains. Macro-particles are then ejected from the molten pools as droplets by the high plasma pressure, and droplets are formed more easily from large superheated pools and they tend to be larger than those from small pools, causing a higher erosion rate of Al.

The eruption of Al grains to form macro-bubbles appearing at the interface between Ti and Al grains occurs only on the 1800 μm -grade. It resembles the phenomenon of a cathode spot anchoring on the liquid metal when an immersed solid metal is present.^{32–35} As an Al grain adjacent to a Ti grain melts, the edge of the Ti grain can effectively be seen as being immersed in liquid Al. It anchors the arc at this position and brings the liquid Al to boil. The boiling Al forms bubbles that solidify when coming in contact with the cooler parts of the cathode surface outside the liquid pool. The diameter of the craters that contain macro-bubbles is more than 200 μm . In order for the cathode spot to anchor, liquid Al must wet the solid metal (Ti) to a certain dimension, which is only fulfilled for the 1800 μm -grade. The grain size is too small for arc anchoring in the other three grades, which explains why macro-bubbles are not observed for these grades.

A crude calculation, when approximating the grains as spheres, gives the interface area in a box of 1 cm^3 to be 17, 300, 600, and 3000 cm^2 for 1800, 100, 50, 10 μm grains, respectively. A material with such a large interface area as the 10 μm -grade is expected to suffer from pronounced phonon scattering, which makes it a poorer thermal conductor compared to the grades of larger grain sizes. Large interfacial areas and poor thermal conductivities are instrumental for the formation of intermetallic phases seen for the 50 and 10 μm -grade during the initial stage of evolution of converted layers. The interfaces between Al and Ti grains are the expected sites for the formation of intermetallic phases. Since there are fewer interfaces in the 1800 and 100 μm -grade as compared to the other grades, there is a low probability for a cathode spot at such an interface and even if the cathode spot finds an interface, the good thermal conductivity of these grades warrants rapid quenching of the melt.

Such rapid quenching does not provide the time needed to form intermetallic phases.

On the other hand, the large interface area and poor thermal conductivities in the cases of 50 and 10 μm -grades generate more favorable conditions for the formation of intermetallic phases. The intermetallic phases in the Ti-Al phase diagram, according to their ascending free energy of formation, are η , ζ , ϵ , and γ .³⁶ Under thermodynamic equilibrium the formation of the ζ phase requires the presence of the γ phase.^{36,37} However, the arcing phenomenon is transient in nature,³⁸ which is in contrast to the thermodynamic equilibrium condition. During such conditions, the kinetics may dominate thermodynamics and lead the system to form the intermetallic ζ phase. The η phase is known to exist in equilibrium with the liquid phase in the Ti-Al phase diagram.³⁶ Since the surface of the 10 μm -grade is expected to retain heat for a longer period of time than the 50 μm -grade, one may expect that thermodynamic equilibrium is reached at localized places to form the η phase along with ζ .

B. Steady-state condition of the converted layers and the effect on coatings

The multiple instances of the cathode spot even out the macro-bubbles observed during the initial stage of the converted layer on the 1800 μm -grade [see Fig. 7(i)]. The presence of both Al and Ti phases in the converted layers on 100 μm -grade and 1800 μm -grade (see Fig. 8) indicates that during the steady-state operation of the cathodes they keep their entity as separate phases in the converted layers. In the converted layer of the 1800 μm -grade, the Al phase has the lowest work function and cohesive energy among the detected phases, and is hence expected to host more cathode spot events and a higher erosion rate compared to Ti and other intermetallic phases. This biased erosion of Al grains creates surface asperities giving rise to a rough appearance. The direct consequence of this phenomenon is the presence of flattened macro-particles on the coatings grown by 1800 μm -grade. Since Al has a lower melting temperature than Ti, it is expected that these flattened macro-particles are Al rich and they require a lower temperature or a longer time to solidify; as a result, these macro-particles reach the substrate in the liquid state. However, the Ti rich macro-particles reach the substrate in a solidified state, resulting in the formation of macro-particles of spherical geometry. The relatively thick (50 μm) converted layer on the surface of 1800 μm -grade is a result of preferential erosion and the anchoring of the cathode spot. This cathode spot behavior dissipates more heat locally, which extends the converted layer to a greater depth compared to the other grades. The preferential erosion of Al (Al ion erosion and Al-rich macro-particles) also explains high Al-content ($\text{Ti}_{0.42}\text{Al}_{0.58}\text{N}$) in the coatings grown from the 1800 μm -grade.

The steady-state condition of the converted layer for the 100 μm -grade is reached in a similar manner as that of the converted layer for the 1800 μm -grade. However, the grain size, in this case, is substantially smaller, which means that the asperities, originating from the preferential erosion of Al, render the adjacent phases having higher work functions, to

form sharp micro-protrusions. The micro-protrusions are known to have a local field enhancement effect during the cathodic arc process,³⁹ which in turn decreases the effective work function for these micro-protrusions. As a consequence, these micro-protrusions are favorable cathode spot sites that act to reduce the surface roughness causing a more uniform erosion of the converted layer. Compared to coatings deposited by the other grades, this uniform erosion process promotes the stoichiometric coatings and generates the lowest macro-particle density.

The lack of Al, presence of a γ phase, and the appearance of sub-holes (porosity) at the steady state condition of the converted layers for the 10 and 50 μm -grade suggest that the cohesion of factors like large interfacial area, poor thermal conductivity, and heat due to arcing provide a prosperous environment for initiation of a self-sustaining reaction underneath the converted layers along the Al channels sandwiched between the Ti grains. As the heat from the cathode is removed by a water cooled Cu plate placed at the backside of the cathode, the surface region of the cathode is expected to be hotter than the bulk region, and is, thus, a preferential region for the self-sustaining reaction wave front to proceed, which explains why the Al channels parallel to the surface form sub-holes.

Compacts of Ti and Al particles are known to initiate a self-sustaining combustion reaction at an adiabatic temperature of 1300 °C that yields the γ phase as the final product;⁴⁰ this reaction proceeds by forming ε phase in an exothermic reaction. The heat generated in this intermediate step further melts Al, heats the compact and activates the diffusion needed to transform ε to γ .^{40,41} Increasing the initial temperature of the Ti-Al compact⁴⁰ and decreasing the grain size of the Ti^{40,42} result in a short initiation time for this self-sustaining reaction. The decrease in the Ti grain size also enhances the speed of the self-sustaining reaction wave front.⁴⁰ At the completion of such self-sustaining reactions the compact is prone to have porosity chiefly due to factors such as Kirkendall porosity where the difference in diffusivity of Al and Ti forms the pores at the Al grain sites⁴³ and the shrinkage porosity is caused by the 5.3% higher density of the γ phase compared to the Ti-Al powder compact.⁴⁴

The primary cause of the appearance of hole-like features on the converted layers of 50 and 10 μm -grade during the steady state [see Figs. 7(iii) and 7(iv)] lies in the work function of the metals that decreases linearly as their temperatures increase.⁴⁵ When heat from the cathode spot initiates a self-sustaining reaction underneath the converted layer, the localized temperature of the constituents of the converted layer directly above the proceeding reaction front increases, causing their work functions to decrease. Such locations offer good conditions for bearing new cathode spots. The temperature is expected to be quite high due to the residual heat generated from the self-sustaining reaction, and the ignition of the cathode spot further increases the temperature of the region surrounding this site. As a consequence, this site melts rapidly, and a deep and wide molten pool is formed. Under plasma pressure, the liquid from this pool is forced out as macro-particles, and thus, deep and wide hole-like features appear.

Besides offering localized places of low work function, the Al phase in the converted layers of the 100 and 1800 μm -grade also provide the pathways for heat conduction because of its high thermal conductivity, while the dearth of Al in the converted layers of the 10 and 50 μm -grades can be expected to yield a poor thermal conductivity. The density of macro-particles is directly proportional to the surface temperature of the cathode.⁴⁶ The high macro-particle density of the coatings grown by 50 μm -grades compared to 100 μm -grade is related to the self-sustaining exothermic reaction, which consumes the Al phase. This consumption reduces the thermal conductivity and further increases the temperature of the converted layer on the 50 μm -grade. During the steady state arcing, the converted layer on the 10 μm -grade displays no Ti phase (see Fig. 8) and abundant hole-like features [see Fig. 7(v)], which suggests that for this even finer microstructure, the conditions for the self-sustaining reaction enabling the formation of γ phase are fulfilled more frequently than for the 50 μm -grade. The high macro-particle density of the coatings grown by the 10 μm -grade (see Fig. 13) is similarly linked to the high temperature of the converted layer due to the dearth of the Al phase and a significantly higher frequency of the self-sustaining reaction.

The absence of the Al-phase in the converted layer also diminishes the difference in work function among the constituents (ζ , ε , η , γ , and Ti) to 0.1 eV;⁴⁷ this reduction in the disparity of the work function provides a nearly equal probability for the cathode spot events. It is also the reason why the arced 50 μm -grade appears smooth compared to other three grades [see Figs. 7(a)–7(d)].

The appearance of flattened macro-particles on the coatings grown by the 10 μm -grade [see Fig. 10(d)] is due to the fact that the hole-like features created by the interaction of self-sustaining reaction and the arc activity are filled with the molten metal pools. Since the liquefied Al channels are formed during the self-sustaining reaction, the molten metal pools in the hole-like features are expected to be rich in Al. This super-hot liquid under plasma pressure is jettisoned towards the substrate, where it strikes the substrate in the liquefied form and upon solidification forms flattened macro-particles. These flattened macro-particles enriched in Al are responsible for the high ($\text{Ti}_{0.44}\text{Al}_{0.56}\text{N}$) Al-content of the coatings grown by the 10 μm -grade. The abundance of these flattened macro-particles in the coatings grown by the 10 μm -grade results in an apparently high growth rate (see Fig. 12).

The maximum of macro-particle density of the coatings grown by the 1800 and 10 μm -grades is shifted towards smaller angles from the normal surface of the cathode compared to other cathode grades (see Fig. 13). The plausible reason for this shift could be that these grades have deep asperities whose walls are quite steep compared to the other grades. The plasma pressure is expected to force the liquid out of such an asperity. The molten liquid held by the walls of the asperity is then guided out in approximately the same direction as the walls. This can be understood from the schema in Fig. 14, which shows how the molten metal under the plasma pressure is jettisoned from (a) shallow asperity as

FIG. 14. Schema of the ejection mechanism of macro-particles from (a) a shallow crater, and (b) a deep and steep crater with the arrow representing the plasma pressure.

in the case of the 100 and 50 μm -grades, and (b) deep and steep asperity as in the case of the 1800 and 10 μm -grades.

V. CONCLUSION

In this article, we report on the evolution of the morphology and microstructure of Ti-50 at.% Al powder metallurgical cathodes, as a function of their grain sizes (1800, 100, 50 and 10 μm), during the cathodic arc deposition of Ti-Al-N coatings. The primary factors that influence the evolution of the microstructure and morphology of the 1800 μm grain sized material are the disparity of the work function among the parent phases, as well as the anchoring of the cathode spots. These two factors contribute to the high Al content in the deposited coatings. The reduction in grain size to 100 μm enhances the intermixing of the parent phases, which mitigates the anchoring phenomenon and results in the coatings having equal content of Ti and Al. Further reduction in the grain size creates favorable conditions for the initiation of the self-sustaining reaction to form the γ phase. For the 10 and 50 μm grain size cathodes the self-sustaining reaction is the dominant factor affecting the evolution of the morphology and microstructure of the cathodes during arcing. On the 10 μm grain size cathode, self-sustaining reactions occur so frequently that the coatings become rich in Al and laden with macro-particles.

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